



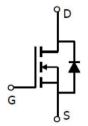
MJ N-Channel Enhancement Mode Power MOSFET

Description

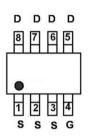
The MJ6007S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ♦ V_{DS} =60V,I_D =7A R_{DS(ON)} <30mΩ @ V_{GS}=10V (Typ:24mΩ) R_{DS(ON)} <35mΩ @ V_{GS}=4.5V (Typ:27mΩ)
- ♦ High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses



Schematic diagram



Application

Power switching application

Uninterruptible power supply

Hard switched and high frequency circuits

Marking and pin assignment

M.

SOP-8 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
6007	MJ6007S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lо	7	А
Drain Current-Continuous(Tc =100°C)	ID(100℃)	5	А
Pulsed Drain Current	Ідм	40	А
Maximum Power Dissipation	Po	2.1	W
Operating Junction and Storage Temperature Range	Тј ,Тѕтс	-55 To 150	°C

Thermal Characteristic





Electrical Characteristics (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Uni
Off Characteristics	·	·				
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V,I _D =250µA	60	69	-	V
Zero Gate Voltage Drain Current	loss	VDS=60V,VGS=0V	-	-	1	μA
Gate-Body Leakage Current	lgss	Igss Vds=±20V,Vds=0V		-	±100	nA
On Characteristics (Note 3)		1	1	1		
Gate Threshold Voltage	VGS(th)	Vos=Vgs ,Io=250µA	1.0	1.4	2.0	V
	5	V _{GS} =10V, I _D =7A	-	24	30	mΩ
Drain-Source On-State Resistance	Rds(on)	Vgs=4.5V, Id=6A	-	27	35	mΩ
Forward Transconductance	G FS	Vds=5V,Id=7A	-	20	-	s
Dynamic Characteristics (Note 4)		1	1	1		1
Input Capacitance	Clss		-	1920	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V F=1.0MHz	-	155	-	PF
Reverse Transfer Capacitance	Crss		-	116	-	PF
Switching Characteristics (Note 4)		1	1			1
Turn-on Delay Time	td(on)		-	8	-	nS
Turn-on Rise Time	tr	- Vdd=30V,RL=4.7Ω	-	5	-	nS
Turn-Off Delay Time	td(off)	$V_{GS}=10V,R_{GEN}=3\Omega$	-	29	-	nS
Turn-Off Fall Time	tr		-	6	-	nS
Total Gate Charge	Qg		-	50	-	nC
Gate-Source Charge	Qgs	V _{DS} =30V,I _D =7A V _{GS} =10V	-	8	-	nC
Gate-Drain Charge	Qgd		-	16		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	Vsd	Vgs=0V,Is=7A	-	-	1.2	V
Diode Forward Current (Note 2)	ls		-	-	7	A
Reverse Recovery Time	trr	T - 25°C 174	-	35	-	nS
Reverse Recovery Charge	Qrr	TJ=25°C, IF=7A di/dt= 100A/µs ^(Note 3)	-	43	-	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is n		 		

Notes:

1 Repetitive Rating: Pulse width limited by maximum junction temperature.

② Surface Mounted on FR4 Board, t \leq 10 sec.

③ Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

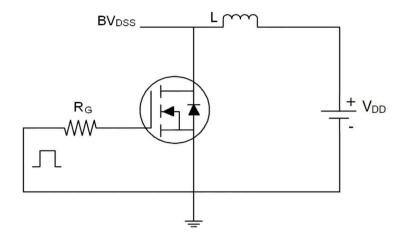
④ Guaranteed by design, not subject to production



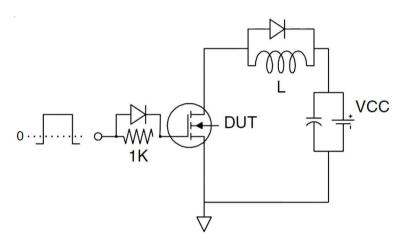




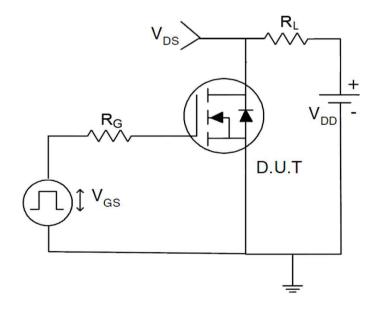
Test circuit







Gate charge test Circuit



Switch Time Test Circuit







Typical Electrical and Thermal Characteristics (Curves)

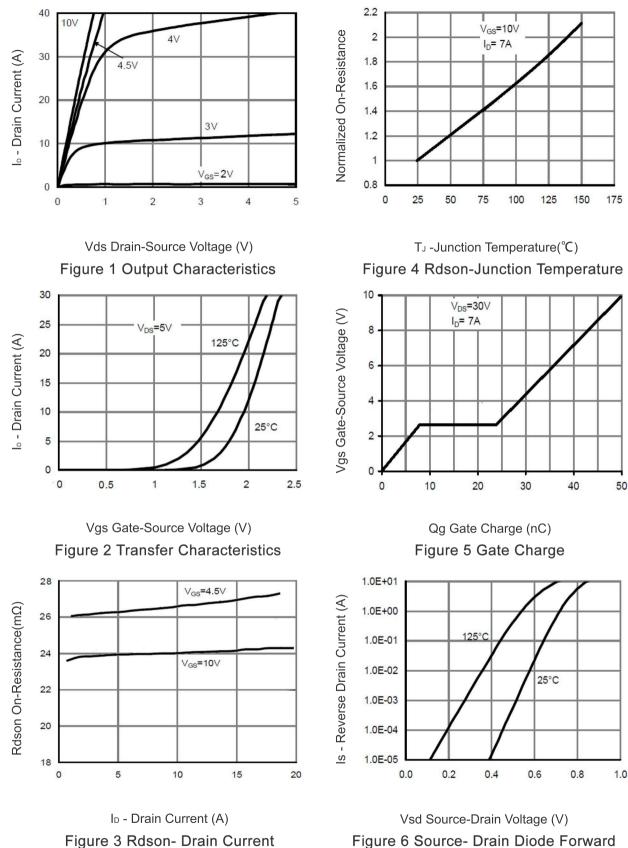


Figure 6 Source- Drain Diode Forward







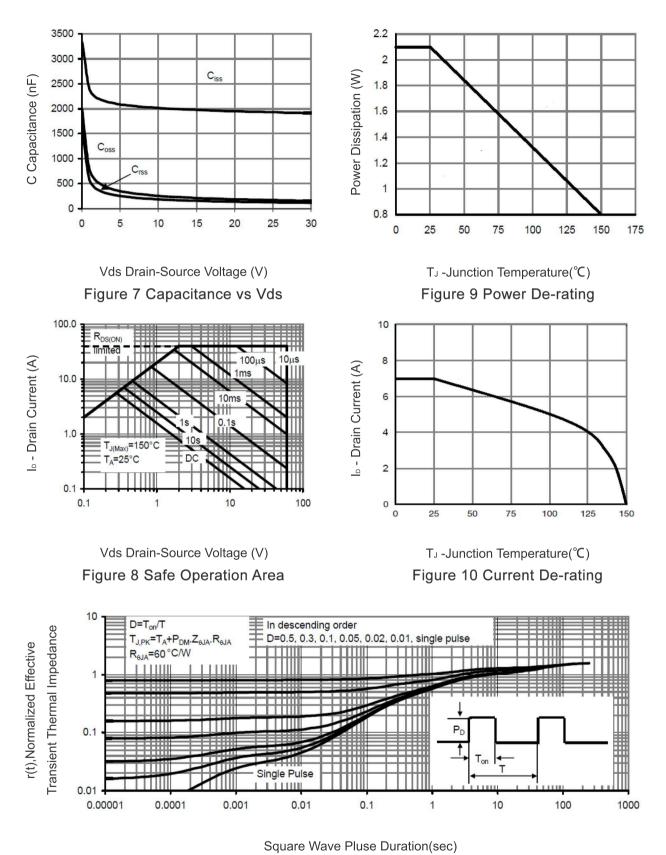


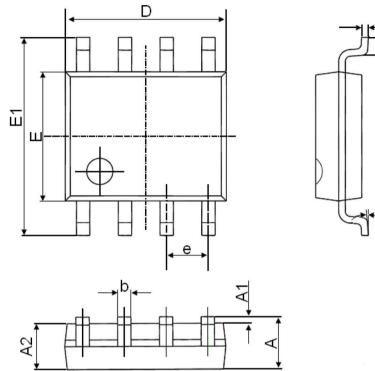
Figure 11 Normalized Maximum Transient Thermal Impedance







SOP-8 Package Information



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)			
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Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	





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